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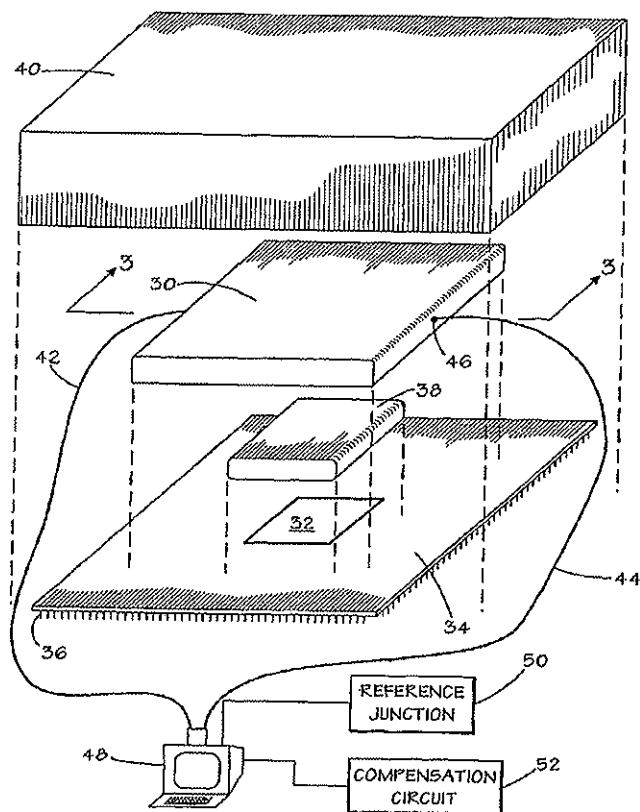
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(54) Title: A CIRCUIT LID WITH A THERMOCOUPLE



(57) Abstract: Various devices for measuring an electronic device lid (30) are provided. In one aspect, an apparatus is provided that includes an integrated circuit (32), a lid (30) for positioning on the integrated circuit (32), and a junction (46) of two dissimilar metals associated with the lid (30). The junction (46) provides a thermocouple that provides an output signal representative of a temperature of the lid (30).